

Product/process change notification

PCN N° 2020-017-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Introduction of an additional wafer production site at Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for EC4_650V and implementation of IGBT MPT in 300 mm Dresden for discrete Products in Advanced Isolation.

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-02-28
- Infineon aligns with the widely recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Infineon Technologies AG

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Chairman of the Supervisory Board: Dr. Wolfgang Eder

Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Constanze Hufenbecher, Dr. Sven Schneider

Registered Office: Neubiberg

Commercial Register: München HRB 126492



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▶ Products affected

Please refer to attached affected product list 1_cip20017_a

▶ Detailed change information

Subject

Introduction of an additional FE wafer site production and implementation of 300mm wafer diameter

Reason

Capacity extension and implementation of a 2nd source

Description

Wafer production and test site EC4 650V

<u>Old</u>

Infineon Technologies Austria AG, Villach

New

 Infineon Technologies (Kulim) Sdn. Bhd., Kulim or Infineon Technologies Austria AG, Villach

Wafer diameter and production, test site IGBT MPT

- 200 mm in Infineon Technologies Austria AG, Villach
- 300 mm in Infineon Technologies Austria AG, Dresden

Product identification

Internal traceability assured via lot code and development code. External traceability assured via Product Bar Code Label / Lot Code

Impact of change

No Impact on parameters and reliability as proven via product qualification. Processes are optimized to meet identical product performance according to already applied Infineon specifications. Updated datasheet are available either on www.infineon.com or at your local sales office.

Attachments

Affected product list: 1_ cip20017_a

Qualification report: 2_ cip20017_a



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▶ Time schedule

■ Final qualification report Available (refer to attachment 2_cip20017_a)

First samples available on request

Intended start of delivery
 2022-04-30 or earlier on specific customer request

If you have any questions, please do not hesitate to contact your local sales office.